Thyristors **Datasheet**

Po

BTB12-600BW3G, BTB12-800BW3G Surface Mount – 800V



Additional Information





Resources

Accessories

Samples

Description

The BTB12 is dAesigned for high performance full-wave AC control applications where high noise immunity and high commutating di/ dt are required.

Features

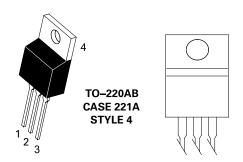
- Blocking Voltage to 800 V
- On-State Current Rating of 12 Amperes RMS at 25°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 2000 V/µs minimum at 125°C

Functional Diagram

- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dl/dt 4. A/ms minimum at 125°C
- These are Pb–Free Devices



Pin Out



Maximum Ratings (TJ = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) BTB12–600BW3G (Gate Open, Sine Wave 50 to 60 Hz, T ₁ = -40° to 125°C) BTB12–800BW3G	V _{drm} , V _{rbm}	600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, T _c = 80°C)	I _{T (RMS)}	12	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T_c = 25°C)	I _{TSM}	120	А
Circuit Fusing Consideration ($t = 10 \text{ ms}$)	l²t	78	A ² sec
Non–Repetitive Surge Peak Off–State Voltage ($T_J = 25^{\circ}$ C, t = 10 ms)	$V_{\rm dSM}/V_{\rm RSM}$	$V_{\rm DSM}/V_{\rm RSM}$ +100	V
Peak Gate Current ($T_J = 125^{\circ}C$, t = 20ms)	I _{GM}	4.0	VV
Peak Gate Power (Pulse Width \leq 1.0 µs, T _c = 80°C)	P _{GM}	20	W
Average Gate Power ($T_{J} = 125^{\circ}C$)	P _{G(AV)}	1.0	W
Operating Junction Temperature Range	T,	-40 to +125	°C
Storage Temperature Range	T _{stq}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the

Recommended Operating Conditions may affect device reliability. 1. V_{DBM} and V_{RBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance	Junction-to-Case (AC) Junction-to-Ambient	R _{ejc} R _{eja}	2.3 60	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds		TL	260	°C

Electrical Characteristics - OFF (TJ = 25°C unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T ₁ = 25°C	I _{DRM} ,	-	-	0.005	
$(V_{D} = V_{DRM} = V_{RRM}; Gate Open)$	T_ = 125°C	I	-	-	1.0	mA

Electrical Characteristics - ON (TJ = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic			Min	Тур	Мах	Unit
Forward On-State Voltage (Note 2) (I _{TM} = ±17 A Peak)		V _{TM}	-	-	1.55	V
	MT2(+), G(+)		2.5	-	50	
Gate Trigger Current (Continuous dc) ($V_D = 12 V$, $R_L = 30 \Omega$)	MT2(+), G(-)	I _{gt}	2.5	-	50	mA
	MT2(-), G(-)		2.5	-	50	
Holding Current ($V_D = 12$ V, Gate Open, Initiating Current = ±100 mA)		I _H	-	-	50	mA
Latching Current ($V_p = 24 \text{ V}$, $I_g = 60 \text{ mA}$)	MT2(+), G(+)		-	-	70	
	MT2(+), G(-)	Ι	-	-	90	mA
	MT2(-), G(-)		-	-	70	
	MT2(+), G(+)		0.5	-	1.7	
Gate Trigger Voltage ($V_D = 12 V$, $R_L = 30 \Omega$)	MT2(+), G(-)	V _{gt}	0.5	-	1.1	V
	MT2(-), G(-)		0.5	-	1.1	
Gate Non-Trigger Voltage ($T_J = 125^{\circ}C$)	MT2(+), G(+)		0.2	-	-	
	MT2(+), G(-)	V _{gd}	0.2	-	_	V
	MT2(-), G(-)		0.2	_	_	

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.



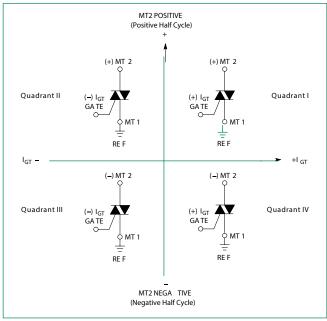
Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Мах	Unit
Rate of Change of Commutating Current, See Figure 10. (Gate Open, T _J = 125°C, No Snubber)	(dl/dt)c	4.0	-	-	A/ms
Critical Rate of Rise of On–State Current ($T_J = 125^{\circ}C$, f = 120 Hz, $I_g = 2 \times I_{gT}$, tr ≤ 100 ns)	dl/dt	-	-	50	A/µs
Critical Rate of Rise of Off-State Voltage ($V_D = 0.66 \times V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^{\circ}$ C)	dV/dt	2000	-	-	V/µs

Voltage Current Characteristic of SCR

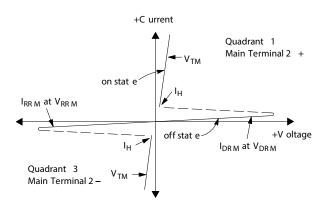
Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used





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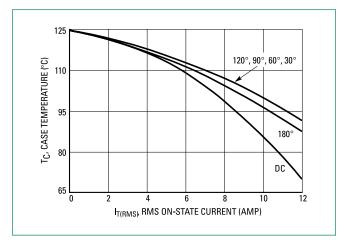


Figure 1. RMS Current Derating

Figure 3. On–State Characteristics

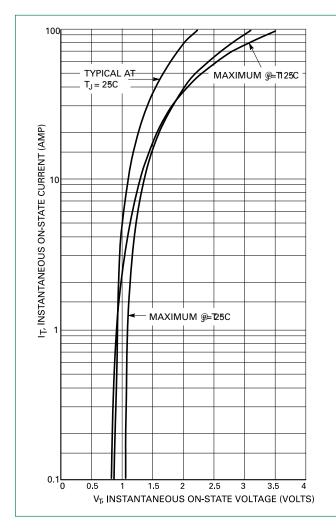


Figure 2. On-State Power Dissipation

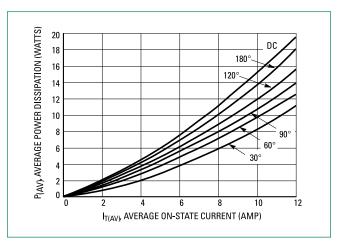


Figure 4. Thermal Response

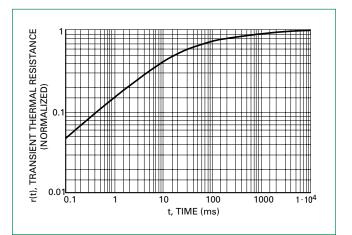
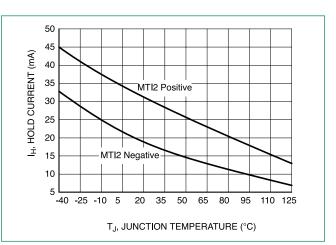


Figure 5. Typical Hold Current Variation



BTB12-600BW3G, BTB12-800BW3G Surface Mount – 800V

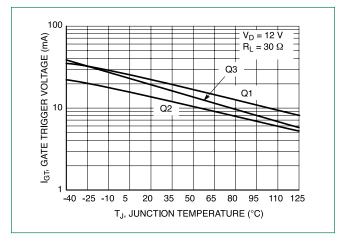


Figure 6. Typical Gate Trigger Current Variation

Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

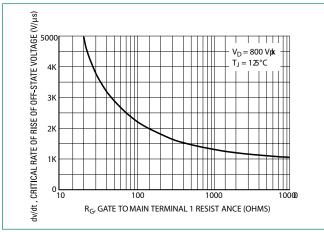


Figure 7. Typical Gate Trigger Voltage Variation

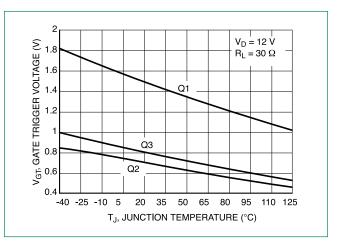
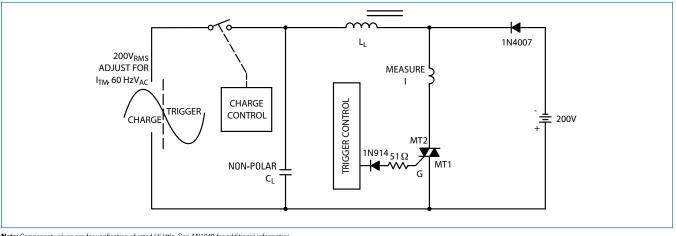


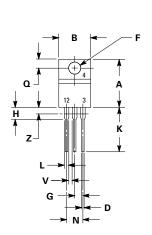
Figure 9. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

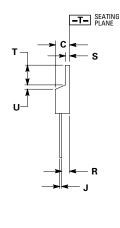




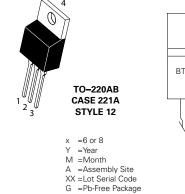
BTB12-600BW3G, BTB12-800BW3G Surface Mount – 800V

Dimensions





Part Marking System





Dim	Inches		Millin	eters	
Dim	Min	Max	Min	Max	
Α	0.590	0.620	14.99	15.75	
В	0.380	0.420	9.65	10.67	
С	0.178	0.188	4.52	4.78	
D	0.025	0.035	0.64	0.89	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.41	2.67	
н	0.110	0.130	2.79	3.30	
J	0.018	0.024	0.46	0.61	
к	0.540	0.575	13.72	14.61	
L	0.060	0.075	1.52	1.91	
N	0.195	0.205	4.95	5.21	
٥	0.105	0.115	2.67	2.92	
R	0.085	0.095	2.16	2.41	
S	0.045	0.060	1.14	1.52	
т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
v	0.045		1.15		
Z		0.080		2.04	

Pin Assignment				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	No Connection			

Ordering Information

Device	Package	Shipping
BTB12-600BW3G	TO-220AB (Pb-Free)	1000 Units / Box
BTB12-800BW3G	TO-220AB (Pb-Free)	1000 Units / Box

Dimensioning and tolerancing per ansi y14.5m, 1982.
Controlling dimension: inch.

3. Dimension z defines a zone where all body and lead irregularities are allowed.

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